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# LONG DURATION VENUS PROBES AND LANDERS

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### OUTLINE

- Unique Challenges of Venus
- Achieving Long Life at the Surface
- Tackling the Challenges
  - Temperature
  - Chemistry
- Current LLISSE\* Testing
- Long Duration Lander Technology Needs
- Summary

\* Long Lived In-situ Solar System Explorer

#### The Unique Challenges of Venus

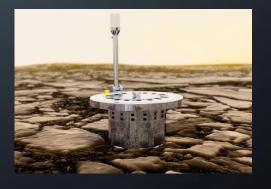
80 km 70km		Layers of thick S clouds limit remo below clouds		-93° C -43° C -23° C
60km				
50 km				67° C
40 km		Little solar energy reaches surface		142°C
30 km				210° C
20 km	High Pressure – CO <sub>2</sub>			390° C
10 km	laden atmosphere		Power at the surface	410° C
0 km S	urface		is a challenge	455° C

Extreme temperatures kill standard lander electronics and systems

### > ACHIEVING LONG LIFE ON THE SURFACE OF VENUS

Approaches to date use large vessels/thermal mass and thermal management techniques to maximize life – best to date ~127mins – Can accomplish a lot of science, but inherently time limited

- Another approach: design a cooled lander requires a lot of power
  Community needs to begin addressing the surface power issue
- GRC approach: design lander to function indefinitely without pressure or temperature control – use all high temperature components
  - Possible now due to advances in high temp.
    electronics/systems
  - GRC Developed over decades for various applications



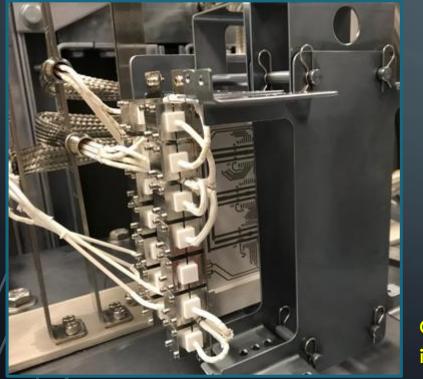


Cooled Lander Concept

LLISSE Concept

#### • CHALLENGES

Needed for long duration operations: High temperature, Pressure and Reactive Chemistry



**Temperature** is the most difficult for electronics and many other components

**Pressure** is not deemed as much of a major challenge for most components

**Reactive chemistry** is an under appreciated issue Sulfur compounds in super critical CO<sub>2</sub> environment react quickly with many common spacecraft materials

Circuit Board inside Cube Structure with Loom Bar Wiring into Alumina Blocks Jun 14, 2019

#### TACKLING THE TEMPERATURE CHALLENGE

Advances in wide band gap electronics are addressing many hurdles

- Sensors, electronics, components, medium complexity IC's, etc. developed, tested
  - Thousands of hours at Venus surface temperatures
  - Months at a time in Venus conditions
- Development continues through several NASA projects
  - HOTTech Various component level activities
  - LLISSE Component & system development for science and operational goals
  - SBIR Small Business Innovative Research awards
- Other government and commercial activity is also occurring
  - <u>https://www.cree.com/news-events/news/article/cree-to-invest-1-billion-to-expand-silicon-carbide-capacity</u>

#### TACKLING THE TEMPERATURE CHALLENGE CONT.

- Near term goal: demonstrate complexity that enables lander functionality
  - Ability to execute pre-planned functions, take and process science measurements, communicate with orbiter
- LLISSE is developing and demonstrating this at lander system level
- HOTTech, separate from LLISSE, is developing various components
  - Different versions of wide band gap electronics, including memory
  - High temperature batteries and other power ideas
  - Motor / motor control
- Near term development targets
  - Increase complexity while lowering power demand
  - Increase system operating speeds –comm to operate at 100's of MHz
  - Continue to evolve batteries to maximize energy deliverable as life increases

#### TACKLING THE CHEMISTRY CHALLENGE

- GEER\* tests reveal: current spacecraft materials may not be suitable for long duration missions
  - E.g. Copper
- GEER tests include: various materials, when approved by primary customers, to build up a database of what works and what doesn't
  - Lukco, D., et al. (2018). Chemical Analysis of Materials Exposed to Venus Temperature and Surface Atmosphere. Earth and Space Science, Volume 5, Issue 7.
- GEER tests continue: investigating material compatibility, coatings, mechanisms, lubricants and other approaches



#### Crystal growth on structure following testing

Material Results after Exposure to Simulated Venus Atmosphere

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Materials	Outcome
Au	No reaction, but mobile
lr	No reaction, but mobile
SiC	No reaction
Cu	Cu <sub>2</sub> S crystals
Ni	NiS crystals
Kovar (Ni-Co-Fe)	NiS, Fe <sub>x</sub> O <sub>y</sub>
AIN	No reaction
Ag-Cu Braze	Segregation into Cu <sub>2</sub> S and Ag; Ag mobile
Inconel 625 (Ni-Cr- Mo-Fe)	NiS, Cr <sub>x</sub> O <sub>y</sub>
304 SS	Mirror finish, low corrosion rate
Sputtered Aluminum	Reacts with HF to form AIF <sub>3</sub>
Titanium	Oxide on surface decreasing into bulk

#### **OUPCOMING LLISSE DEMONSTRATION**

• LLISSE demo test later this calendar year, testing system and component level operations

- Goals:

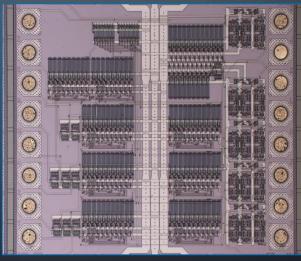
- ✓ Operate 60 days in Venus conditions
- $\checkmark$  Read and process instrument and sensor data periodically
- $\checkmark$  Test breadboard with sensors, avionics, communications (1-10MHz), and battery



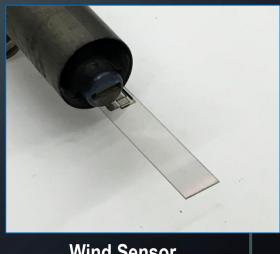
Cube Structure Circuit Board Wiring Going to Loom Bar Location



**Thermal Battery** 



Integrated core clock/counter/ comparison chip



Wind Sensor

# <sup>°</sup> FUTURE TECHNOLOGY NEEDS FOR LANDERS

- VEXAG recently updated its Technology Plan which describes technology needs.
  Some specific needs for high temp materials based landers include:
- Long term needs
  - Develop low power memory and critical circuits (E.g. timer/clock)
  - High temperature receiver and more capable comm
  - Develop sensors for situational awareness high temperature camera / optics
  - Improved science sensors and instruments
- For even longer term
  - High temperature "permanent" power 100's of watts to could support
    - Permanent stations seismology and meteorology
    - Cooling for advanced instruments and high performance electronics / computing
    - Surface mobility

#### **SUMMARY**

Long Duration Venus Landers Pose unique technical challenges i.e., temperature and reactive chemistry

Venus Surface Probes & Landers

LLISSE Project

"Permanent" Power System Can survive weeks to months -Technically feasible in next 5-10 years

Addressing challenges - In development

- A lot is already done
- Continues to be demonstrated

Long life and 100's of watts of surface power needed to understand Venus in the longer term

Now

Continue to Developing Landers such as LLISSE: - Can make important science strides - Pave the way for more sophisticated landers

# BACK-UP

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# LIST OF CURRENT HOTTECH TASKS

P.I.	Title	Project Duration	TRL Start/Finish
Simon Ang, / Univ. of Arkansas	500°C Capable, Weather-Resistant Electronics Packaging for Extreme Environment Exploration	2	2,5
Ratnakumar Bugga / JPL	High Temperature-resilient and Long Life (HiTALL) Primary Batteries for Venus and Mercury Surface Missions	2	3,4
Jonathan Grandidier /JPL	Low Intensity High Temperature (LIHT) Solar Cells for Venus Exploration Mission	2	2,4
Jitendra Kumar / Univ. of Dayton	Higher Energy, Long Cycle Life, and Extreme Temperature Lithium Sulfur Battery for Venus Missions	3	3,5
Michael Paul / JHUAPL	Hot Operating Temperature Lithium combustion IN situ Energy and Power System (HOTLINE Power System)	3	2,5
Darby Makel / Makel Engr. Inc.	SiC Electronics To Enable Long-Lived Chemical Sensor Measurements at the Venus Surface	3	3-4, 6
Robert Nemanich/ Arizona State Univ.	High Temperature Diamond Electronics for Actuators and Sensors	3	3,5
Phil Neudeck / NASA GRC	High Temperature Memory Electronics for Long-Lived Venus Missions	3	3-4, 6
Leora Peltz/ Boeing Corp.	Field Emission Vacuum Electronic Devices for Operation above 500 degrees Celsius	3	3,5
Debbie Senesky / Stanford Univ.	Passively Compensated Low-Power Chip-Scale Clocks for Wireless Communication in Harsh Environments	2	2,4
Kris Zacny / Honeybee Robotics Corp.	Development of a TRL6 Electric Motor and Position Sensor for Venus	2	5,6
Yuji Zhao / Univ. of Arizona	High Temperature GaN Microprocessor for Space Applications	3	